

# Lenovo PX

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Product Name	PX
Product Display Name	ThinkStation PX
Information Date	16-Jun-25
Hardware Maintenance Manual	<a href="#">PX HMM</a>
Drivers & Software	<a href="#">PX Drivers &amp; Software</a>
Available Whitepapers	<a href="#">Power Configurator</a> <a href="#">Memory Configurator</a> <a href="#">Storage Configurator</a> <a href="#">Intel VROC Configurator</a> <a href="#">Discrete RAID Configurator</a> <a href="#">Windows 11 Installation</a> <a href="#">Windows 10 Installation</a> <a href="#">Red Hat Enterprise Linux 9 Installation</a> <a href="#">Ubuntu Linux 22.04 LTS Installation</a> <a href="#">BMC Installation Guide</a> <a href="#">Intel AMT</a> <a href="#">ThinkStation WiFi Solutions</a>

## SECTION I: Platform Overview

Description	The pinnacle of Lenovo technology, the ThinkStation PX goes beyond the limits of desktop performance to enable even the most extreme workflows. Featuring a thermally advanced chassis co-designed with Aston Martin, the latest dual 4th Gen Intel Xeon Scalable processors, up to 120 cores, and support for up to four NVIDIA RTX6000 Ada Generation GPUs, this workstation powerhouse runs the most complex computing workloads seamlessly.
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### CPU

Processor Support	Dual 4th/5th Generation Intel Xeon Scalable Processors
Socket Type	Socket-E (LGA-4677)
Disclaimers	

### Operating Systems

Preloaded	Windows 11 Pro 64-bit for Workstation Ubuntu 22.04 LTS (configuration specific)
Supported	Red Hat Enterprise Linux 9.2 Red Hat Enterprise Linux 9.4 Ubuntu 20.04 LTS Ubuntu 22.04 LTS
Disclaimers	

### Memory

Slots	Up to 16 DIMMS (8 DIMMs per CPU)
Channels	8 Memory Channels per CPU
Type	DDR5, 288-Pin, ECC RDIMM and 3DS RDIMM*
ECC Support	Yes

Speed	Up to 5600MHz
Max DIMM Size	128GB DDR5 ECC RDIMM 128GB DDR5 ECC 3DS-RDIMM
Max System Memory	2TB
Disclaimers	*Actual Memory Speed is dependent on the CPU.

## Storage

Total Bays/Size	Up to 4
SATA	3 x SFF-8680 Receptacles 1 x SATA 3.0 Connectors
PCIe (M.2)	3 x M.2 NVMe 2280 PCIe Connectors Onboard 4 x M.2 NVMe 2280 Front Accessible Drives
Disclaimers	*See Storage Whitepaper for details on the available usage options.

## Video

Integrated Graphics	Not Available
Discrete Graphics	NVIDIA T400(MiniDP x3) – 4GB GDDR6, PCIe3, Single-Slot NVIDIA T1000(MiniDP x4) – 8GB GDDR6, PCIe3, Single-Slot NVIDIA RTX A2000(MiniDP x4) – 12GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX A4000 (DP x4) – 16GB GDDR6, PCIe4, Single-Slot NVIDIA RTX A4500(DP x4) – 20GB, GDDR6, PCIe4, Dual-Slot NVIDIA RTX A5000(DP x4) – 24GB, GDDR6, PCIe4, Dual-Slot NVIDIA RTX A5500(DP x4) – 24GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX A6000(DP x4) – 48GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX6000 Ada(DP x4) – 48GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX5880 Ada(DP x4) – 48GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX5000 Ada(DP x4) – 32GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX4500 Ada(DP x4) – 24GB GDDR6, PCIe4, Dual-Slot NVIDIA RTX4000 Ada(DP x4) – 20GB GDDR6, PCIe4, Single-Slot NVIDIA A1000(MiniDP x4) – 8GB GDDR6, PCIe4, Single-Slot NVIDIA A400(MiniDP x4) – 4GB GDDR6, PCIe4, Single-Slot NVIDIA A800 – 40GB GDDR6, PCIe4, Dual-Slot NVIDIA Quadro SYNC II card
Multi-GPU Support	Yes
Type	PCIe Add-In-Card
Bus Interface	PCIe x16
Disclaimers	

## Slots

Slot 1	PCIe 4.0 x16, Full Height, Full Length, 75W (CPU 2)
Slot 2	PCIe 4.0 x16, Full Height, Full Length, 75W (CPU 2)
Slot 3	PCIe 5.0 x16, Full Height, Full Length, 75W (CPU 2)
Slot 4	PCIe 5.0 x16, Full Height, Full Length, 75W (CPU 2)
Slot 5	PCIe 4.0 x8, Full Height, Full Length, 25W, Open Ended (CPU 2)
Slot 6	PCIe 5.0 x16, Full Height, Full Length, 75W (CPU 1)
Slot 7	PCIe 4.0 x16, Full Height, Full Length, 75W (CPU 1)
Slot 8	PCIe 5.0 x16, Full Height, Full Length, 75W (CPU 1)
Slot 9	PCIe 4.0 x16, Full Height, Full Length, 75W (CPU 1)
Disclaimers	

## Front I/O

USB	1 x USB-A 3.2 Gen 2 (10Gbps) 1 x USB-A 3.2 Gen 2 (10Gbps) (with Always On Charging) 2 x USB-C 3.2 Gen 2 (10Gbps)
Audio	1 x 3.5mm Global Headset Jack (Headphone + Mic in)

Media Card Reader	N/A
Flex Bay	3 x Front access drive bay Rear Flex Storage Enclosure (Shared with 2nd PSU Bay)
Disclaimers	Note: Actual USB throughput will vary depending on the type and quantity of USB devices used.

## Rear I/O

USB	2 x USB-A 2.0 (480Mbps) 4 x USB-A 3.2 Gen 1 (5Gbps) 1 x USB-C 3.2 Gen 2x2 (20Gbps)
Audio	2 x Rear (Line Out, Line In retasked as Mic)
DisplayPort	As Supported by GPU
HDMI	As Supported by GPU
Serial Port	Optional 1x Rear Port
Ethernet	1 x 1GbE – RJ45 1 x 10GbE – RJ45
PS/2	Optional PS/2 (2 port) PCIe adapter
Optional Network Adapter	Broadcom 5720 Dual Port Gigabit PCIe Ethernet Adapter Broadcom 5719 Quad Port Gigabit PCIe Ethernet Adapter Bitland RTL8168H 1000M PCIe Ethernet Adapter Intel I210-T1 Single Port Gigabit PCIe Ethernet Adapter Intel I350-T2 Dual Port Gigabit PCIe Ethernet Adapter Intel I350-T4 Quad Port Gigabit PCIe Ethernet Adapter Intel AX210 WIFI PCIe Adapter with Internal Antennas NVIDIA ConnectX-6 25G 2-Ports Adapter
Disclaimers	Note: Actual USB throughput will vary depending on the type and quantity of USB devices used.

## Ethernet

Vendor	Aquantia 10 GbE AQC113C-B1-C Intel 1 GbE I219 (Vpro, AMT)
Speeds	10/100/1000/10000Mbps Aquantia AQC113C 10/100/1000Mbps Intel I219
Functions	PXE, WOL, Jumbo Frames ASF, Teaming (Intel only)
Connectors	2 x RJ45
Disclaimers	Note: Network speeds listed are theoretical.


## Audio

Vendor	Realtek
Type	HD (2.0)
Internal Speaker	1 x 1.5 watt 4 ohm
Connectors	2 x Rear 3.5mm Jacks (Line Out, Line In retasked as Mic) 1 x Front 3.5mm Global Headset Jack (Headphone + Mic in)
Chipset	Realtek ALC897Q Codec (rear) Realtec ALC4032 (front)
Number of Channels	Rear Audio: 2 Channels Front Audio: 2 Channels
Number of Bits/Audio Resolution	Rear Codec: 10 Channel DAC Supports 16/20/24-bit PCM 2 Stereo ADC Supports 16/20/24-bit PCM Front Codec: One stereo DAC supports 8/16/22.05/24/32/44.1/48/96/176.4/192KHz Sample Rate, 16/24-bit One stereo ADC supports 8/16/22.05/24/32/44.1/48/96KHz Sample Rate, 16/24-bit
Disclaimers	*Note: Audio Codec ALC897Q can support 7.1 channel, but motherboard only has 2 rear jacks – MIC in and Line out, only 2 channel for Line out.

## Thermal

Temp Sensors	Ambient Cabled Sensor – Thermistor, MB Header cabled to chassis front bezel PCIe Zone 1 Sensor – Thermistor PCIe Zone 2 Sensor – Thermistor PCIe Zone 3 Sensor – Thermistor PCIe Zone 4 Sensor – Thermistor M.2 Zone 1 Sensor – Thermistor M.2 Zone 2 Sensor – Thermistor MISC Sensor – Thermistor HDD 1 Sensor – I2C Temp Sensor HDD 2 Sensor – I2C Temp Sensor HDD 3 Sensor – I2C Temp Sensor PSU Bay 2 (HDD) Sensor – I2C Temp Sensor
Fans	2 x Front Fans (FRONT_FAN1) – 6-pin blind connect 1 Connector per 2 Fans 1 x Front Fan (FRONT_FAN2) – 4-pin blind connect 1 Connector per 1 Fans 1 x Front Fan (FRONT_FAN3) – 4-pin blind connect 1 Connector per 1 Fans 2 x Rear Fans (REAR_FAN1) – 6-pin blind connect 1 Connector per 2 Fans 1 x CPU 1 Fan (CPU1_FAN) – 4-pin header with 3-pin key 1 x CPU 2 Fan (CPU2_FAN) – 4-pin header with 3-pin key 1 x PSU HDD Fan (PSU_HDD_FAN) – PSU Edge Connector 3 x HDD Fans (HDD_FAN_X) – 4-pin header with 3-pin key 2 x PSU1 Fans – internal of PSU 2 x PSU2 Fans – internal of PSU 1 x CPU1 Memory Fan – CPU1_Pump_DDR – 4-pin header with 3-pin key 1 x CPU2 Memory Fan – CPU2_Pump_DDR – 4-pin header with 3-pin key
Disclaimers	

## Power Specifications

Power Supply	1850 watts
Power Efficiency	92% Efficient @ 50% Load
Main	C20
Operating Voltage Range	100 – 240V (autosensing)
Rated Voltage Range	90-264VAC
Rated Line Frequency	47Hz / 63Hz
Operating Line Frequency Range	50Hz / 60Hz
Rated Input Current	13 – 20A
Graphics	Up to 8 x 8-pin (6+2) PCIe*
Power Supply Fan	Yes
ENERGY STAR  Qualified (config dependent)	Yes
80 PLUS Compliant	Yes
Built-in Self Test (BIST) LED	Yes
Disclaimers	*Quantity of Graphics power cables is configuration dependent *See Power Configuration Whitepaper for additional details.

## BIOS

Vendor	AMI
Disclaimers	

## Chassis Information

Color	Storm Gray
PSU	One Fixed 1850W, Autosensing, 92% PSU, 80 PLUS Platinum Qualified Optional: 2nd 1850W, Autosensing, 92% PSU, 80 PLUS Platinum Qualified
Thermal Solutions	2 Rear Fans 4 Front Fans 1 Fan per storage bay 1 Fan per CPU 2 Fans per PSU Memory Fans (configuration dependent)
Dimensions	434.4mm/17.1" H (without feet) 440.4mm/17.3" H (with feet) 575mm/22.6" D 220mm/8.7" W

Weight	35.6 kg / 78.48 lbs
Disclaimers	

## Packaging Dimensions

Height (mm/in)	658mm / 25.91"
Width (mm/in)	397mm / 15.63"
Depth (mm/in)	802mm / 31.57"
Weight (kgs/lbs)	40.135 kg / 88.48 lbs
Disclaimers	

## Security & Serviceability

TPM	Infineon SPI TPM SLB9672 TPM 2.0
Asset ID	Yes, 1024 x 8bit
vPro	Yes
Cable Lock Support	Yes, Optional Kensington Cable Lock
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes
Power-On Password	Yes
Setup Password	Yes
NIC LEDs (integrated)	Yes
Access Panel Key Lock	Yes
Boot Sequence Control	Yes
Padlock Support	No
Boot Without Keyboard and/or Mouse	Yes
Access Panel	Tool-less Side Cover Removal
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less*
Color Coded User Touch Points	Yes
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Retained with Screws
Restore CD/DVD/USB Set	Not Included, Restore Media Available via Lenovo Download Recovery Service or available through Lenovo Support.
Disclaimers	*Note: CPU Heatsink assembly requires a T30 bit.

## Operating Environment

Air Temperature	Operating: 10_C to 35_C (50_F to 95_F)
Storage	Storage: -40_C to 60_C (-40_F to 140_F) in Original Shipping Carton Storage: -10_C to 60_C (14_F to 140_F) Without Carton
Humidity	Relative Humidity Operating: 10% to 80% (non-condensing) Relative Humidity Storage/Transit: 10% to 90% (non-condensing) Wet Bulb Temperature Operating: 25_C (77_F) max Wet Bulb Temperature Non-operating: 40_C (104_F) max
Altitude	Upper limits decrease 1C (1.8F) per 300 m (1000 ft) above sea level
Vibration	Operating Vibration: Random, 0.27G at 5-500 Hz, 30 Minutes Per Surface (X,Y,Z) Non-Operating Vibration: Random, 1.04G at 2-200 Hz, 15 Minutes Per Surface (X,Y,Z)
Shock	Operating: X,Y axis: +- 15G/3ms Z axis: +- 30G/3ms Operating (Rack mounted): X,Y,Z axis: +- 15G/3ms Non-operating target: Trapezoidal shock, 35g average, 11ms

Disclaimers	Extended operating temperatures are possible – please contact your Lenovo Rep
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## SECTION II: Platform Detail

Board Size	16.26" x 15.43" (413mm x 392mm)
Layout	Lenovo Custom Extended ATX

### Motherboard Core

Processor Support	Intel Sapphire Rapids – Xeon Scalable Processors (Platinum, Gold, Silver) Intel Emerald Rapids – Xeon Scalable Processors (Platinum, Gold, Silver)
Socket Type	Socket E (LGA 4677)
Memory Support	DDR5 up to 5600MHz RDIMM / 3DS RDIMM Memory
CPU-CPU Interconnect	Intel UPI v2.0, 3 links, x24, at speeds 12.8GT/s, 14.4GT/s and 16GT/s
Voltage Regulator	Intel VR14.0 – 400W TDP Capable
Chipset (PCH)	Intel Emmitsburg (Intel C741 Series)
Flash	2 x 64MB
Super I/O	2 x MEC1723(176 pin)
Clock	External Clock
Audio	Rear Codec: Realtek ALC897Q (Rear I/O) Front Codec: Realtek ALC4032 (FPiO)
Ethernet	Aquantia 10Gb AQCI3C-B1-C Intel 1Gb I219

### Supported Components

Processor Level	Intel Xeon Platinum	Intel Xeon Gold	Intel Xeon Silver
Processor	Intel Xeon Emerald Rapids Platinum 8592+ Intel Xeon Emerald Rapids Platinum 8580 Intel Xeon Emerald Rapids Platinum 8570 Intel Xeon Emerald Rapids Platinum 8568Y+ Intel Xeon Sapphire Rapids Platinum 8490H Intel Xeon Sapphire Rapids Platinum 8468	Intel Xeon Emerald Rapids Gold 6548Y+ Intel Xeon Emerald Rapids Gold 6544Y Intel Xeon Emerald Rapids Gold 6542Y Intel Xeon Emerald Rapids Gold 6534 Intel Xeon Emerald Rapids Gold 6530 Intel Xeon Emerald Rapids Gold 6526Y Intel Xeon Emerald Rapids Gold 6444Y Intel Xeon Sapphire Rapids Gold 6442Y Intel Xeon Sapphire Rapids Gold 6438Y+ Intel Xeon Sapphire Rapids Gold 6430 Intel Xeon Sapphire Rapids Gold 6418H Intel Xeon Sapphire Rapids Gold 6416H Intel Xeon Sapphire Rapids Gold 5420+ Intel Xeon Sapphire Rapids Gold 5418Y Intel Xeon Sapphire Rapids Gold 5416S Intel Xeon Sapphire Rapids Gold 5415+	Intel Xeon Sapphire Rapids Silver 4416+ Intel Xeon Sapphire Rapids Silver 4410Y Intel Xeon Sapphire Rapids Silver 4410T
Memory Type	RDIMMs – 5600MT/s, CPU Dependent RDIMMs – 4800MT/s, CPU Dependent	3DS-RDIMMs – 4800MT/s, CPU Dependent	
Memory	16GB DDR5 ECC RDIMM PC5-5600 32GB DDR5 ECC RDIMM PC5-5600 64GB DDR5 ECC RDIMM PC5-5600 128GB DDR5 ECC RDIMM PC5-5600 16GB DDR5 ECC RDIMM PC5-4800 32GB DDR5 ECC RDIMM PC5-4800 64GB DDR5 ECC RDIMM PC5-4800	128GB DDR5 ECC 3DS-RDIMM PC5-4800	
Disclaimers	Additional CPU SKU's certified.		

### Storage

3.5" SATA Hard Disk Drive (HDD)	2TB SATA – 7200rpm, 6Gb/s, 3.5" 4TB SATA – 7200rpm, 6Gb/s, 3.5" (Enterprise Class) 6TB SATA – 7200rpm, 6Gb/s, 3.5" (Enterprise Class) 12TB SATA – 7200rpm, 6Gb/s, 3.5" (Enterprise Class)
M.2 PCIe Solid State Drive (SSD)	512GB M.2 PCIe – SSD, 2280, Gen5 (x4), NVMe, TLC, OPAL2.0 1024GB M.2 PCIe – SSD, 2280, Gen5 (x4), NVMe, TLC, OPAL2.0

	2048GB M.2 PCIe – SSD, 2280, Gen5 (x4), NVMe, TLC, OPAL2.0 4096GB M.2 PCIe – SSD, 2280, Gen5 (x4), NVMe, TLC, OPAL2.0 512GB M.2 PCIe – SSD, 2280, Gen4 (x4), NVMe, TLC, OPAL2.0 1024GB M.2 PCIe – SSD, 2280, Gen4 (x4), NVMe, TLC, OPAL2.0 2048GB M.2 PCIe – SSD, 2280, Gen4 (x4), NVMe, TLC, OPAL2.0 4096GB M.2 PCIe – SSD, 2280, Gen4 (x4), NVMe, TLC, OPAL2.0
Disclaimers	Additional Storage devices certified.

## RAID

RAID Requirements	M.2 and SATA RAID via Intel VROC Controller
Notes	Supported RAID levels for a system will vary from the stated capabilities of the RAID controller due to dependencies on the number and capacity of physical disks in the system and on customer requirements for performance, fault tolerance, or data redundancy. Max supported RAID 0/1/5/10.
Intel VROC	Intel Virtual RAID On CPU (VROC) – Basic, Supports 0/1/10 Intel Virtual RAID On CPU (VROC) – Premium, Supports 0/1/5/10

## Optical Drive/Removable Media

## Keyboard and Pointing Devices

Keyboard	USB Traditional Keyboard PS/2 Tradition Keyboard Smart Card Keyboard USB Calliope Keyboard USB Calliope AI Keyboard
Pointing Devices	USB Fingerprint Mouse USB Calliope Mouse PS/2 Black Optical Mouse

## Expansion Bays

5.25" External Access Bays	3 x Front access drive bays 1 x Rear PSU bay storage enclosure (Utilizes 2nd PSU bay)*
Disclaimers	See Storage Configuration whitepaper for detailed usage *Only available on single PSU configurations

## PCIe Adapters

Network	Broadcom 5720 Dual Port Gigabit Ethernet Adapter Broadcom 5719 Quad Port Gigabit Ethernet Adapter Bitland RTL8168H 1000M PCI-E Ethernet Adapter Intel I210-T1 Single Port Gigabit Ethernet Adapter Intel I350-T2 Dual Port Gigabit Ethernet Adapter Intel I350-T4 Quad Port Gigabit Ethernet Adapter NVIDIA ConnectX-6 25G 2-Ports Adapter
Thunderbolt	Rear Maple Ridge Thunderbolt PCIe Adapter
WiFi Cards	Intel PCIe WiFi Card With BT Internal Antenna Kit (AX210 6E)
PS/2	PS/2 (2-Port) PCIe adapter
Com port	Serial COM port cable with 5V transceiver
PCIe to M.2 Adapter Card	ThinkStation PCIe Gen4 Quad M.2 SSD Adapter ThinkStation PCIe Gen5 Quad M.2 SSD Adapter
Other	BMC PCIe Adapter

## SECTION III: Supported Component Detail

### CPU Specifications Group 1

CPU	Intel XEON Sapphire Rapids Platinum 8490H	Intel XEON Sapphire Rapids Platinum 8468	Intel XEON Sapphire Rapids Gold 6442Y	Intel XEON Sapphire Rapids Gold 6438Y+	Intel XEON Sapphire Rapids Gold 6430
Disclaimers					

### CPU Specifications Group 2

CPU	Intel XEON Sapphire Rapids Gold 6418H	Intel XEON Sapphire Rapids Gold 6416H	Intel XEON Sapphire Rapids Gold 5420+	Intel XEON Sapphire Rapids Gold 5418Y	Intel XEON Sapphire Rapids Gold 5416S
Disclaimers					

### CPU Specifications Group 3

CPU	Intel XEON Sapphire Rapids Gold 5415+	Intel XEON Sapphire Rapids Silver 4416+	Intel XEON Sapphire Rapids Silver 4410Y	Intel XEON Sapphire Rapids Silver 4410T
Disclaimers				

### HDD Specifications Group 1

Drive	500GB SATA – 7200rpm, 6Gb/s, 2.5"	1TB SATA – 7200rpm, 6Gb/s, 3.5"	2TB SATA – 7200rpm, 6Gb/s, 3.5"	4TB SATA – 7200rpm, 6Gb/s, 3.5"
3.5_ SATA Hard Disk Drive (HDD)	Not Available	Yes	Yes	Yes
2.5_ SATA Hard Disk Drive (HDD)	Yes	Not Available	Not Available	Not Available
Connector	SATA	SATA	SATA	SATA
Transfer Rate (Gb/sec)	160MB/s OD read	Average data rate, read/write 156MB/s	Average data rate, read/write 156MB/s	Sustained data transfer rate 216 – 226MB/s
Spindle Speed (RPM)	7,200	7,200	7,200	7,200
DC Power to Drive Ready (sec)	3.5	<10.0	<17.0	<17.0
Average Latency (msec)	4.2	4.16	4.16	4.16
Input (VDC)	5	5	5	5
Typical (Watts)	1.9	6.19	6.7	7.35
Idle (Watts)	0.7	4.6	4.5	5.45
Physical Dimensions	69.85mm x 100.34mm x 7mm	101.6mm x 146.99mm x 19.88mm	101.6mm x 146.99mm x 26.1mm	101.85mm x 147mm x 26.1mm
Weight (grams)	90	420	535	680
Operating (C) Ambient	0 to 60	0 to 60	0 to 60	5 to 60
Operating (C) Base Casting	60	60	60	60
Non-Operating (C) Ambient	(-40 to 70)	(-40 to 70)	(-40 to 70)	(-40 to 70)
Gradient (C per Hour)	20	20	20	20
Operating (Gs @ 2ms)	400	70	80	Read 70 Gs / Write 40 Gs
Non-Operating (Gs @ 2ms)	1000	350	300	300
Disclaimers				

### HDD Specifications Group 2

Drive	6TB SATA – 7200rpm, 6Gb/s, 3.5"
3.5_ SATA Hard Disk Drive (HDD)	Yes
2.5_ SATA Hard Disk Drive (HDD)	Not Available
Connector	SATA
Transfer Rate (Gb/sec)	Sustained data transfer rate 216 – 226MB/s
Spindle Speed (RPM)	7,200



DC Power to Drive Ready (sec)	<17.0
Average Latency (msec)	4.16
Input (VDC)	5
Typical (Watts)	8.13
Idle (Watts)	6.21
Physical Dimensions	101.85mm x 147mm x 26.1mm
Weight (grams)	705
Operating (C) Ambient	5 to 60
Operating (C) Base Casting	60
Non-Operating (C) Ambient	(-40 to 70)
Gradient (C per Hour)	20
Operating (Gs @ 2ms)	Read 70 Gs / Write 40 Gs
Non-Operating (Gs @ 2ms)	250
Disclaimers	

## Solid State Storage Specifications Group 1

Drive	256GB NVMe M.2 SSD TLC	512GB NVMe M.2 SSD TLC	1024GB NVMe M.2 SSD TLC	2048GB NVMe M.2 SSD TLC	480GB AIC Optane SSD
Dimensions Millimeters (W x D x H)	22 x 80 x 2.3	22 x 80 x 2.3	22 x 80 x 2.3	22 x 80 x 2.3	20 x 168 x 104
Interface Type	PCIe Gen 3.0 x4 NVMe	PCIe Gen 3.0 x4 NVMe	PCIe Gen 3.0 x4 NVMe	PCIe Gen 3.0 x4 NVMe	PCIe Gen 3.0 x4 NVMe
Power Active (AVG)	5W	5W	5W	5W	18W
Power Idle	50mW	50mW	50mW	50mW	7W
Typical Sequential Read	3000MB/s	3200MB/s	3200MB/s	3500MB/s	2700MB/s
Typical Sequential Write	1300MB/s	1600MB/s	1600MB/s	3000MB/s	2200MB/s
Operating Temperature Range	0 to 55C	0 to 55C	0 to 55C	0 to 55C	0 to 85C
Endurance Rating (Lifetime Writes)	85TB	150TB	300TB	600TB	8.76PB
Mean Time Between Failures (MTBF)	2.0M POH	2.0M POH	2.0M POH	2.0M POH	2.0M POH
Hardware Encryption	AES 256 bit	AES 256 bit	AES 256 bit	AES 256 bit	No
Disclaimers	SSD performance measured with Crystal Disk Mark version 6.0.2 with the default 1000 MB data set. Sequential measurements are with 1 Thread, Queue-Depth 32. Random measurements are with 4 threads and queue-depth 32.				

## Solid State Storage Specifications Group 2

Drive	1.5TB U.2 Optane SSD
Dimensions Millimeters (W x D x H)	70 x 100 x 15
Interface Type	PCIe Gen 3.0 x4 NVMe
Power Active (AVG)	18W
Power Idle	7W
Typical Sequential Read	2700MB/s
Typical Sequential Write	2200MB/s
Operating Temperature Range	0 to 85C
Endurance Rating (Lifetime Writes)	27.3PB
Mean Time Between Failures (MTBF)	2.0M POH
Hardware Encryption	No
Disclaimers	SSD performance measured with Crystal Disk Mark version 6.0.2 with the default 1000 MB data set. Sequential measurements are with 1 Thread, Queue-Depth 32. Random measurements are with 4 threads and queue-depth 32.

## HDD Controllers

PCI Bus	PCH Integrated
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PCI Modes	SATA 3.0
RAID Levels	0/1/5/10
Data Transfer Rates	6Gb/s
Internal Connectors	2 x MiniSAS HD (2 ports each) + 3 x SATA
Disclaimers	

## Optical Drive Specifications

Operating Systems Supported	Windows 10 Pro for Workstations (Preload) Windows 7 Pro 64 Red Hat Enterprise Linux 7.3 Ubuntu 16.04 and 18.04.2
Temperature	10°C – 35°C (50°F – 95°F)
Relative Humidity	10%-80% (non-condensing)
Maximum Wet Bulb Temperature	25°C max
Disclaimers	
Disclaimers	

## Discrete Graphics Adapter Group 1

Adapter	T400	T1000	RTX A2000	RTX A4000	RTX A4500
Bus Interface	PCIe 3.0 x16	PCIe 3.0 x16	PCIe 4.0 x16	PCIe 4.0 x16	PCIe 4.0 x16
Display Interface	3 x mDP 1.4	4 x mDP 1.4	4 x mDP 1.4a	4 x DP 1.4a	4 x DP 1.4
Graphics Chipset	Turing	Turing	Coming Soon	Ampere	Coming Soon
Memory Clock Frequency (MHz)	Coming Soon	Coming Soon	Coming Soon	Coming Soon	Coming Soon
Memory Size	2GB GDDR6	4GB GDDR6	Coming Soon	16GB GDDR6	Coming Soon
Memory Interface	64-bit	128-bit	Coming Soon	256-bit	Coming Soon
Memory Bandwidth	80GB/s	160GB/s	Coming Soon	448 GB/s	Coming Soon
GPU Cores	CUDA Cores: 384	CUDA Cores: 896	Coming Soon	CUDA Cores: 6411 Tensor Cores: 192 RT Cores: 48	Coming Soon
Maximum Power Consumption	30W	50W	Coming Soon	140W	Coming Soon
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or Digital)	Coming Soon	Coming Soon	4 x 4096x2160 @ 120Hz 4 x 5120x2880 @ 60Hz 2 x 7680x4320 @ 60Hz	Coming Soon	Coming Soon
Thermal Solution	Active	Active	Coming Soon	Active	Coming Soon
Dimension	2.7" H x 6.1" L Single Slot	2.7" H x 6.1" L Single Slot	Coming Soon	4.4" H x 9.5" L Single Slot	Coming Soon
Advanced Display	Coming Soon	Coming Soon	Coming Soon	SYNC 2	Coming Soon
SLI/NVLink Support	Coming Soon	Coming Soon	Coming Soon	Coming Soon	Coming Soon
Disclaimers					

## Discrete Graphics Adapter Group 2

Adapter	RTX A5500	RTX A6000	RTX 6000 Ada
Bus Interface	PCIe 4.0 x16	PCIe 4.0 x16	Coming Soon
Display Interface	4 x DP 1.4a	4 x DP 1.4a	Coming Soon
Graphics Chipset	Coming Soon	Ampere	Coming Soon
Memory Clock Frequency (MHz)	Coming Soon	2000MHz	Coming Soon
Memory Size	Coming Soon	48GB GDDR6	Coming Soon
Memory Interface	Coming Soon	384-bit	Coming Soon
Memory Bandwidth	Coming Soon	Up to 768GB/s	Coming Soon
GPU Cores	Coming Soon	CUDA Cores: 10,752 Tensor Cores: 336	Coming Soon

		RT Cores: 84	
Maximum Power Consumption	Coming Soon	300W	Coming Soon
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or Digital)	Coming Soon	4 x 4096x2160 @ 120Hz 4 x 5120x2880 @ 60Hz 2 x 7680x4320 @ 60Hz	Coming Soon
Thermal Solution	Coming Soon	Active	Coming Soon
Dimension	Coming Soon	4.4" H x 10.5" L Dual Slot, Full Height	Coming Soon
Advanced Display	Coming Soon	SYNC 2	Coming Soon
SLI/NVLink Support	Coming Soon	NVLink	Coming Soon
Disclaimers			

## Ethernet Specifications Group 1 Part 1

Card	Intel I210-T1 Single Port Gigabit Ethernet Adapter (Springville)	Intel I350-T2 Dual Port Gigabit Ethernet Adapter (Stony Lake T2)	Intel I350-T4 Quad Port Gigabit Ethernet Adapter (Stony Lake T4)	Intel X540-T2 Dual Port Copper 10Gb Ethernet Adapter	Intel X710-DA2 Dual Port Fiber 10Gb Ethernet Adapter
Supplier PN	I210T1, MM# 941033	I350T2G1P20, MM# 928941	I350T4G1P20, MM# 928942	MM#928955	MM# 952103
Data Rates Supported	10/100/1000Mbps copper	10/100/1000Mbps (Copper), 1000Mbps (Fiber)	10/100/1000Mbps (Copper), 1000Mbps (Fiber)	100/1000Mbps and 10Gbps Copper	1GbE/10GbE Optical fiber 10GbE Direct Attach (DAC)
Controller Details	Intel Ethernet Controller I210	Intel Ethernet Controller I350	Intel Ethernet Controller I351	Intel Ethernet Controller X540	Intel Ethernet Controller X710-AM2
Controller Bus Architecture	PCIe 2.1 (5GT/s)	PCIe 2.1 (5GT/s)	PCIe 2.1 (5GT/s)	PCIe 2.1 (5GT/s)	PCIe 3.0 (8GT/s)
Data Transfer Mode	Ethernet	Ethernet	Ethernet	Ethernet	Ethernet
Power Consumption	0.81W	Copper: I350-T2 V2= 4.4W Fiber: I350-F2= 5.5W	Copper: I350-T4 V2= 5W LC-Fiber: I350-F4= 6W	X540-T2: 10Gps= 17.4W 1Gbps= 9.5W 100Mbps=6.6W X540-T1: 10Gbps=10.8W 1Gbps= 7.7W 100Mbps= 6.4W	Dual-port 10GBASE-SR= 4.3W typ/4.8W max Dual-port 1000BASE-SX= 4W typ/4.3W max Dual-port 10GBASE-LR= 4.5W typ/ 5.1W max Dual-port Direct Attach (Twinax)= 3.3W typ/3.7W max
IEEE Standards Compliance	IEEE 802.3/10BASE-T, 100BASE-TX, 1000BASE-T	IEEE 802.3/10BASE-T, 100BASE-TX, 1000BASE-T	IEEE 802.3/10BASE-T, 100BASE-TX, 1000BASE-T	IEEE 802.3 100/1000/10GBASE-T	IEEE 802.3 1/10/10GBASE-SR/LR, SFF-8431 10GSFP+DAC
Boot ROM Support	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI	PXE boot, Intel iSCSI Remote Boot for Windows, Linux and Vmware, Intel BootAgent Software via PXE or BootP, WDMS or UEFI
Network Transfer Mode (Full/Half Duplex)	Supported	Supported	Supported	Supported	Supported
Network Transfer Rate	1,000Mbps Full Duplex	1,000Mbps Full Duplex	1,000Mbps Full Duplex	1,000Mbps Full Duplex	1,000Mbps Full Duplex
Operating System Driver Support	Windows 7/8/10, Linux, Free BSD, XEN,Vmware	Windows 7/8/10, Linux, Free BSD, XEN,Vmware	Windows 7/8/10, Linux, Free BSD, XEN,Vmware	Windows 7/8/10, Windows ServerLinux, FreeBSD	Windows 2008, 2012; RHEL 6.5/7.0, FreeBSD 9/10, Vmware ESXi 5.x
Manageability	Supported	Supported	Supported	Supported	Supported
Manageability Capabilities Alerting	Supported	Supported	Supported	Supported	Supported
TDP	Firmware Based Thermal Management	Firmware Based Thermal Management	Firmware Based Thermal Management	Firmware Based Thermal Management	Not Available
Operating Temperature Range	0C to 55C (32F to 131F)	0C to 55C (32F to 131F)	0C to 55C (32F to 131F)	0C to 55C (32F to 131F)	0C to 55C (32F to 131F)
# of Ports	1	2	4	2	2
Data Rate Per Port	10/100/1000Mbps (copper)	10/100/1000Mbps (copper), 1000Mbps (fiber)	10/100/1000Mbps (copper), 1000Mbps (fiber)	100/1,000Mbps, 10Gbps	1Gbps, 10Gbps
System Interface Type	PCIe Gen 2.1	PCIe Gen 2.1	PCIe Gen 2.1	PCIe Gen 2.1	PCIe 3.0
NC Sideband Interface	Not Available	Not Available	Not Available	Not Available	Yes
Jumbo Frames Supported	Yes	Yes	Yes	Yes	Yes
1000Base-T	Yes	Yes	Yes	Yes	Not Available
IEEE 1588	Supported	Supported	Supported	Not Available	Supported
Supported Under vPro	Not Available	Not Available	Not Available	Not Available	Not Available
Disclaimers					

## Ethernet Specifications Group 1 Part 2

Model	i210-T1	Dual Port Copper= I350-T2V2 Dual Port LC-Fiber= I350-F2	Dual Port Copper= I350-T4 V2 Dual Port LC-Fiber= I350-F4	Dual Port Copper= X540-T2	X710-DA2
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Connector	RJ-45 Copper	2 x Ports RJ-45 Copper or 2 x Ports LC-Fiber	4 x Ports RJ-45 Copper or 4 x Ports LC-Fiber	2 x Ports RJ-45 Copper	2 x SFPs Receptable
Website	i210 T1	i350 T2/F2	i350 T4/F4	x540 T2	x710 DA2
Auto-Negotiation	IEEE* 802.3* Auto-negotiaton	IEEE* 802.3* Auto-negotiaton	IEEE* 802.3* Auto-negotiaton	IEEE* 802.3* Auto-negotiaton	IEEE* 802.3* Auto-negotiaton
Intel vPro	Not Available	Not Available	Not Available	Not Available	Not Available
Intel Standard Manageability	Supported	Supported	Supported	Supported	Supported
Power Optimizer Platform Low-power Management Systems	Supported	Supported	Supported	Supported	Supported
Energy Efficient Ethernet	Supported	Supported	Supported	Not Available	Supported
TCP/UDP Checksum and Segmentation Offload (IPv4 and IPv6)	Supported	Supported	Supported	Supported	Supported
Receive Side Scaling	Supported	Supported	Supported	Supported	Supported
Dual Tx and Rx Queues	Yes	Yes	Yes	Yes	Yes
Jumbo Frames (up to 9KB)	Supported	Supported	Supported	Not Available	Supported
Teaming	Supported	Supported	Supported	Supported	Supported
Wake from Deep Sx	Supported	Supported	Supported	Not Available	Not Available
Server Operating System Support	Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Free BSD, Xen, Vmware	Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Free BSD, Xen, Vmware	Windows Server 2008, 2012, 2016, 2019 Linux (RHEL/SLES), Free BSD, Xen, Vmware	Windows Server 2003, 2008; RHEL 4, Linux/SLES 11, Vmware	Windows 2008, 2012; RHEL 6.5/7.0, FreeBSD 9/10, Vmware ESXi 5.x
Network Proxy/ARP Support	Supported	Supported	Supported	Supported	Supported
Disclaimers					

## Ethernet Specifications Group 2 Part 1

Card	Intel Ethernet SFP+ SR Optics Module	Intel Dual Band Wireless-AC 7260 ASM	Intel Winstorm Peak 8265 2x2 AC+BT 4.2 Vpro M.2 Combo
Supplier PN	MM#: 941243	7260HMWDTX.R, MM# 936170	MM#: 946658
Data Rates Supported	Not Available	Intel Dual Band Wireless-AC 7260	Intel Dual Band Wireless-AC 8265
Controller Details	Not Available	Intel Dual Band Wireless-AC 7260, Dual Band, 2x2, WiFi+BT	Intel Dual Band Wireless-AC 8265, 2x2, WiFi+BT, MU-MIMO
Controller Bus Architecture	Not Available	PCIe M.2	PCIe M.2
Data Transfer Mode	Not Available	WiFi (802.11ac), 2.4GHz, 5GHz	WiFi (802.11ac), 2.4GHz, 5GHz
Power Consumption	Not Available	Not Available	Not Available
IEEE Standards Compliance	Not Available	IEEE 802.11abgn, 802.11ac, 802.11d, 802.11e, 802.11i, 802.11h, 802.11w	IEEE 802.11abgn, 802.11ac, 802.11d, 802.11e, 802.11i, 802.11h, 802.11w, 802.11r, 802.11k, 802.11v (pending)
Boot ROM Support	Not Available	Not Available	Not Available
Network Transfer Mode (Full/Half Duplex)	Not Available	Not Available	Not Available
Network Transfer Rate	Not Available	300/867Mbps	867Mbps
Operating System Driver Support	Not Available	Windows 10, 32-bit*, Windows 10, 64-bit*, Windows 8.1, 32-bit*, Windows 8.1, 64-bit*, Windows 8, 32-bit*, Windows 8, 64-bit*, Windows 7, 32-bit*, Windows 7, 64-bit*, Linux*	Windows 10, 64-bit*, Windows 8.1, 64-bit*, Windows 7, 32-bit*, Windows 7, 64-bit*, Linux*
Manageability	Not Available	Not Available	Not Available
Manageability Capabilities Alerting	Not Available	Not Available	Not Available
TDP	Not Available	Not Available	Not Available
Operating Temperature Range	Not Available	0C to 80C (32F to 176F)	0C to 80C (32F to 176F)
# of Ports	Not Available	Not Available	Not Available
Data Rate Per Port	Not Available	Not Available	Not Available
System Interface Type	Not Available	PCIe M.2	PCIe M.2
NC Sideband Interface	Not Available	Not Available	Not Available
Jumbo Frames Supported	Not Available	Not Available	Not Available
1000Base-T	Not Available	Not Available	Not Available
IEEE 1588	Not Available	Not Available	Not Available
Supported Under vPro	Not Available	Supported	Supported
Disclaimers			

## Ethernet Specifications Group 2 Part 2

Model	AC 7260 NGW	AC 8265 NGW
Connector	2 x Antennas	2 x Antennas
Website	7260 NGW	8265 NGW
Auto-Negotiation	Not Available	Not Available
Intel vPro	Supported	Supported
Intel Standard Manageability	Not Available	Not Available
Power Optimizer Platform Low-power Management Systems	Supported	Supported
Energy Efficient Ethernet	Not Available	Not Available
TCP/UDP Checksum and Segmentation Offload (IPv4 and IPv6)	Not Available	Not Available
Receive Side Scaling	Not Available	Not Available
Dual Tx and Rx Queues	Not Available	Not Available
Jumbo Frames (up to 9KB)	Not Available	Not Available
Teaming	Not Available	Not Available
Wake from Deep Sx	Not Available	Not Available
Server Operating System Support	Not Available	Not Available
Network Proxy/ARP Support	Not Available	Not Available
Disclaimers		

## Media Card Reader

Description	9-in-1 (USB 2.0)
Disclaimers	

## SECTION IV: BIOS/Certifications/Standards/Environmental

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### BIOS Specifications

WMI Support	Compliant With Microsoft WBEM and the DMTF Common Information Model
ROM-Based Setup Utility (F1)	System Configuration Setup Program (text only interface) Available at Power-on With F1 Key
Bootblock Recovery	Recovers System BIOS if the Flash ROM Becomes Corrupted
Replicated Setup	Saves System Configuration Settings to a File That Can Then be Used to Replicate the Settings to Other Systems
Boot Control	Boot Control Available Through ROM-based Setup Utility or With F12 Key at Power-on
Memory Change Alert	Power-on Error Message in the Event of a Decrease in System Memory
Thermal Alert	Power-on Error message in the Event of a Fan Failure
Asset Tag	Supports Ability to Set SMBIOS Type 2 Baseboard Asset Tag Field
System/Emergency ROM Flash Recovery With Video	Supports Process to Recover the System BIOS if the Flash ROM Becomes Corrupted
Remote Wakeup/Remote Shutdown	System Admin Can Power On/Off a Client Computer from a Remote Location to Provide Maintenance
Quick Resume Time	Supports Low Power S3 (suspend to RAM) and Prompt Resume Times
ROM Revision Level	System UEFI (BIOS) Version Reported in SMBIOS Type 0 Structure and in BIOS Setup
Keyboard-less Operation	System Can be Booted Without a Keyboard
Per-port Control	Allows I/O Ports to be Individually Enabled/Disabled Through ROM-based Setup or WMI Interface
Adaptive Cooling	Offers Multiple Settings for Fan Control Ranging Between Better Performance and Better Acoustics
Security	User and Administrator Passwords Can Protect Boot and ROM-based Setup - Support Electronic Lock - Chassis Intrusion Detection - UEFI Secure Boot Support - HDD Password Can Protect HDD Data - Windows UEFI Firmware Update Support - Device Guard Support - Optional Access Panel Lock, Kensington Lock, and Pad Lock

Intel(R) AMT (includes ASF 2.0)	Allows System to be Supported from a Remote Location
Intel(R) TXT	Intel(R) Trusted Execution Technology Provides a Security Foundation to Build Protections Against Software Based Attacks
Memory Modes	Supports Mirroring, Lock Step, and Sparing Memory Modes
Windows 10 Ready	Supports Windows 10 Requirements for Secure Flash, UEFI v 2.6 Device Guard Support Spec

## Industry Standard Specification Support

UEFI	Unified Extensible Firmware Interface v2.7
ACPI (Advanced Configuration and Power management Interface)	Advanced Configuration and Power Interface v6.1
ASF 2.0	DMTF Alert Standard Format Specification v2.0
ATA (IDE)	ATA Attachment 6 with Packet Interface (ATA/ATAPI-6)
CD Boot	EI Torito Bootable CD-Rom Format Specification, v1.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision v1.0
PCI	NA (No PCI slot)
PCI Express	PCI Express Base Specification v3.0
SATA	Serial ATA Revision 3.0 Specification
TPM	Trusted Computing Group TPM Specification v2.0
UHCI	Universal Host Controller Interface Design Guide, Revision v1.1
USB	Universal Serial Bus Revision v1.1 Universal Serial Bus v2.0 Universal Serial Bus v3.0
SMBIOS	DMTF System Management Spec v3.2.1
XHCI	XHCI SPEC Revision v1.2

## Social and Environmental Responsibility

Quality Control	Lenovo is a member of an eco declaration system that enforces regular independent quality control
Hazardous Substances and Preparation	Products do not contain more than; 0.1% lead, 0.01% cadmium, 0.1% mercury, 0.1% hexavalent chromium, 0.1% polybrominated biphenyls (PBB) or 0.1% polybrominated diphenyl ethers (PBDE). (See legal reference and Note B1) Products do not contain Asbestos Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorocarbons (HCFC), Halons, carbontetrachloride, 1,1,1-trichloroethane, methyl bromide Products do not contain more than; 0.005% polychlorinated biphenyl (PCB), 0.005% polychlorinated terphenyl (PCT) in preparation Products do not contain more than 0.1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the chain containing at least 48% per mass of chlorine in the SCCP Parts with direct and prolonged skin contact do not release nickel in concentrations above 0.5 microgram/cm_/_week REACH Article 33 information about substances in articles is available at: <a href="http://www.lenovo.com/social_responsibility/us/en/ThinkGreen_products.html#environment">http://www.lenovo.com/social_responsibility/us/en/ThinkGreen_products.html#environment</a>
Batteries	Not Available
Safety, EMC Connection to the Telephone Network and Labeling	Not Applicable, no Connection to a Telephone Network

## Safety, EMC Connection to the Telephone Network and Labeling

System Software Manager	Lenovo ThinkStation Supports Software Management Tools by Lenovo Vantage
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## Regulations & Standards

EMC & Safety	FCC DoC for North America VCCI Certification for Japan BSMI Certification for Taiwan EU/EFTA CE Mark & DoC UL/CUL(P920,P720,P520,P520c), cTUVus(P330) UL-GS(P920,P720,P520,P520c), TUV-GS(P330) IEC60950-1 CB Report/Certificate Saudi Arabia SASO Kuwait KUCAS China CCC Mark Hong Kong SAR (CB report) Singapore PSB South Africa SABS Russia-EAC Morocco-CM Mexico-NOM
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Kazakhstan-EAC  
 Belarus-EAC  
 Serbia KVALITET  
 Ukraine UKrCEPRO  
 India-BIS  
 USA Chemical Emission Test

## Environmentals

Energy Star	ENERGY STAR v7.0
EPEAT	EPEAT Silver Certification Available on Select Models
Greenguard	Greenguard
RoHS	RoHS Compliant
ErP Lot-3 2013	Yes
Hazardous Substances	<p>Products do not contain more than; 0.1% lead, 0.01% cadmium, 0.1% mercury, 0.1% hexavalent chromium, 0.1% polybrominated biphenyls (PBB) or 0.1% polybrominated diphenol ethers (PBDE)</p> <p>Products do not contain Asbestos</p> <p>Products do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), hydrobromofluorocarbons (HBFC), hydrochlorofluorocarbons (HCFC), Halons, carbontetrachloride, 1,1,1-trichloroethane, methyl bromide</p> <p>Products do not contain more than; 0.005% polychlorinated biphenyl (PCB), 0.005% polychlorinated terphenyl (PCT) in preparation</p> <p>Products do not contain more than 0.1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the chain containing at least 48% per mass of chlorine in the SCCP</p> <p>Parts with direct and prolonged skin contact do not release nickel in concentrations above 0.5 microgram/cm_/week</p>
Disclaimers	EPEAT registered where applicable. EPEAT registration varies by country. See <a href="http://www.epeat.net">www.epeat.net</a> for registration status by country.